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Chapter Glossary

(APG)	Annealed Pyrolytic Graphite
(ARC)	Ames Research Center
(ATA)	Active Thermal Architecture
(BIRD)	Bi-Spectral Infrared Detection
(CSE, USU)	Center for Space Engineering at Utah State University
(ESPA)	EELV Secondary Payload Adapter
(FEP)	Fluorinated Ethylene Propylene
(FETS)	Folding Elastic Thermal Surface
(FOX)	Flat-Plate Heat Pipe On-Orbit Experiment
(GFTS)	Graphite Fiber Thermal Straps
(GSFC)	Goddard Space Flight Center
(HEC)	High Efficiency Cooler
(IR)	Infrared
(ISS)	International Space Station
(KGS)	Kaneka Graphite Sheets
(MLI)	Multi-Layer Insulation
(MPFL)	Mechanically Pumped Fluid Loop
(MWIR)	Midwave Infrared
(NLAS)	Nanosatellite Launch Adapter System
(P-POD)	Poly-Picosatellite Orbital Deployer
(PFL)	Pumped Fluid Loop
(PGF)	Pyrovo Pyrolytic Graphite Film
(PGS)	Pyrolytic Graphite Sheets
(PRISM)	Portable Remote Imaging Spectrometer
(q_{albedo})	Solar heating reflected by the planet
(Q_{gen})	Heat generated by the spacecraft
($Q_{\text{out,rad}}$)	Heat emitted via radiation
($q_{\text{planetshine}}$)	IR heating from the planet



(q_{solar})	Solar heating
(Q_{stored})	Heat stored by the spacecraft
(SDL)	Space Dynamics Laboratory
(SI)	International System of Units
(SPOT)	Standard Passive Orbital Thermal-Control
(SST)	Small Satellite Technology
(TAFTS)	Two Arm Flexible Thermal Strap
(TEC)	Thermoelectric Coolers
(TMT)	Thermal Management Technologies
(TRL)	Technology Readiness Level
(TSU)	Thermal Storage Unit
(UAM)	Ultrasonic additive manufacturing
(ULP)	Ultra-Low Power

7.0 Thermal Control

7.1 Introduction

All spacecraft components have a range of allowable temperatures that must be maintained to meet survival and operational requirements during all mission phases. Spacecraft temperatures are determined by how much heat is input to, stored, and output from the spacecraft. Figure 7.1 shows a simplified overview of heat into and out of an orbiting satellite. The image shows the Earth as the orbited planet, but it applies to any planet or body a spacecraft is orbiting. Q_{gen} , $Q_{out,rad}$, and Q_{stored} are represented as heat values, Watts in International System of Units (SI), whereas q_{solar} , q_{albedo} , and $q_{planetshine}$ are represented as heat fluxes, Watts per square meter in SI.

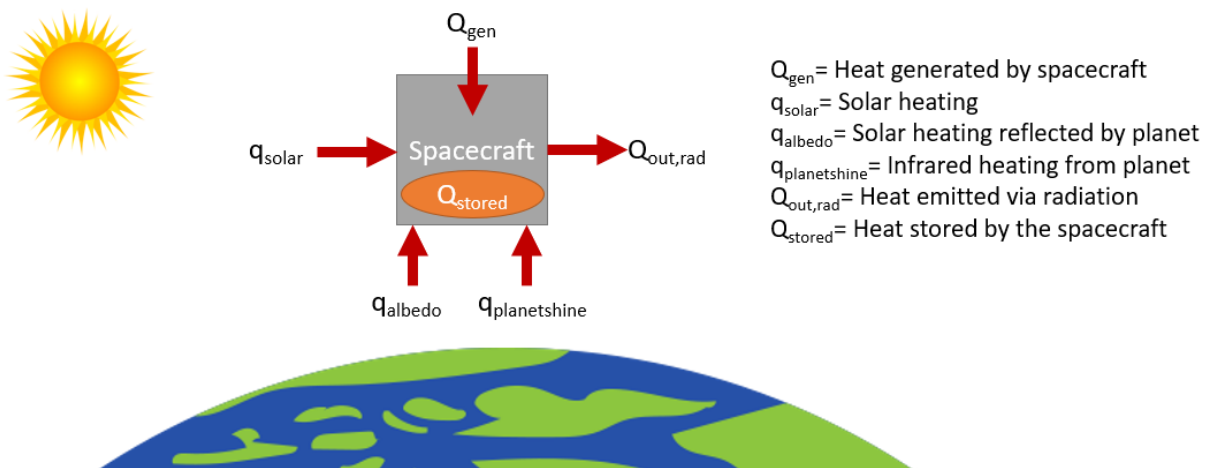


Figure 7.1: Orbiting spacecraft heating simplified overview. Credit: NASA.

The amount of heat absorbed, stored, and dissipated by the spacecraft depends on several factors, listed below. Solar absorptivity and infrared (IR) emissivity are surface optical properties referenced below and are described further in section 7.2.1: Paints, Coatings, and Tapes.

- Q_{gen} (heat generated by the spacecraft) depends on the power and efficiency of spacecraft components.
- The amount of q_{solar} (solar heating) absorbed by the spacecraft depends on the solar flux, which is determined by distance to the sun, the surface area viewing the sun, and the solar absorptivity of that surface.
- The amount of q_{albedo} (solar heating reflected by the planet) absorbed by the spacecraft depends on the planet, the surface area viewing the planet, and the solar absorptivity of that surface.
- The amount of $q_{planetshine}$ (IR heating from the planet) absorbed by the spacecraft depends on the planet, the surface area viewing the planet, and the IR emissivity of that surface.
- $Q_{out,rad}$ (heat emitted via radiation) depends on the surface area designated as radiator space, the IR emissivity of the surface, and the difference in temperature between the spacecraft radiator and the heat sink to which it is dissipating, typically and most effectively deep space. $Q_{out,rad}$ may also include heat lost through insulation or other surfaces not specifically intended to function as radiators.
- Q_{stored} (heat stored by the spacecraft), is based on the thermal capacitance of the spacecraft.

Temperatures are regulated with passive and/or active thermal management technology and design methods. Many of the same thermal management methods used on larger spacecraft are



also applicable to SmallSats and given the increased interest in small spacecraft over the last decade, some spacecraft thermal control technologies have been miniaturized or otherwise adapted to apply to SmallSats. Thermal control methods and technologies as applied to large spacecraft are considered state-of-the-art for the purposes of this review but may have a Technology Readiness Level (TRL) value less than 9 for small spacecraft applications.

Challenges of designing a thermal control system for a SmallSat stem from four intrinsic properties, summarized in table 7-1.

Table 7-1: SmallSat Thermal Control Challenges	
SmallSat Property	Challenge
Low thermal mass	The spacecraft is more reactive to changing thermal environments.
Limited external surface area	There is less real estate to be allocated to solar cells, designated radiator area, and/or viewports required for science instruments.
Limited volume	There is less space for electronic components, science instruments, and thermal control hardware. Components can be more thermally coupled.
Limited power	There is less power available for powered thermal control technology.

The information described in this section is not exhaustive but provides an overview of current state-of-the-art thermal technologies and their development. TRL designations may vary with changes specific to the payload, mission requirements, reliability considerations, and/or the environment in which performance was demonstrated. Readers are highly encouraged to reach out to companies for further information regarding the performance and TRL of described technology. There is no intention of mentioning certain companies and omitting others based on their technologies or relationship with NASA.

7.2 State-of-the-Art – Passive Systems

Passive thermal control maintains component temperatures without using powered equipment. Passive systems are typically associated with low cost, volume, weight, and risk, and so are advantageous to spacecraft with limited, mass, volume, and power, like SmallSats and especially CubeSats. Multi-layer Insulation (MLI), coatings/surface finishes, interface conductance, heat pipes, sunshades, thermal straps, interface materials, and louvers are some examples of passive thermal control technology.

In addition to passive thermal control technology, structural and electrical design methods also contribute to managing the thermal environment, passively. These design methods include:

- Material selection
 - Structural component materials chosen based on needed heat transfer through the structure. A high or low thermal conductivity may be more advantageous based on the application.
- Spacecraft orientation
 - If orientation is not dictated by science objectives, changing the orientation of the spacecraft can help maintain temperatures.
 - Changing orientation may only be needed during certain mission phases, such as science operation if larger amounts of heat are dissipated.
 - This method is often used in conjunction with other thermal control methods, such as orienting the spacecraft so that the radiator area can face deep space.



- Thermal interfaces
 - Dictation of thermal contact between components through specific mounting methods can thermally isolate components or allow more heat to be transferred to a structural element (or radiator area) when each is needed.
 - Heat transfer can be reduced by mounting a component through multiple stacked washers with low thermal conductivity.
 - Heat transfer can be increased by mounting components with more fasteners (if applicable) and can be further increased by using thermal interface materials between a component and mounting surface.
- Circuit board design considerations
 - Copper layers within each board can be increased to conduct heat away from electrical components through the boards to their structural connection points.
 - Circuit boards can be mounted to increase heat transfer away from the boards to the structure, such as by mounting with wedge locks.

Table 7-2 is a list of current passive thermal control technology as applied to SmallSats. One key factor to consider when choosing thermal control technology, both passive and active, is the temperature limits of the technology, itself. The goal is to use the appropriate technology to maintain the temperatures of spacecraft components within their limits, but the technology used to achieve this also has limits. It is recommended to verify that the technology used is applicable to the given design not only with respect to needed function, but to the environment (temperature limits), as well.

Table 7-2: Passive Thermal Technology		
Manufacturer	Product	TRL in LEO Environments
AZ Technology, MAP, Astral Technology Unlimited, Inc., Dunmore Aerospace, AkzoNobel Aerospace Coatings, Parker-Lord, Medtherm	Paint and Coatings	7-9
Sheldahl, Dunmore, Aerospace Fabrication & Materials, 3M	Tapes	7-9
Sheldahl, Dunmore, Aerospace Fabrication & Materials	MLI Materials	7-9
NASA GSFC, Aerothreads, Aerospace Fabrication & Materials	MLI Blanket Fabrication	7-9
Space Dynamics Laboratory, Thermal Management Technologies, Aavid, Technology Applications, Inc., Thermotive Technology	Thermal Straps	7-9
Bergquist, Parker Chomerics, Aerospace Fabrication & Materials, AIM Products LLC, Intermark USA, Indium Corporation, Dow Corning, NeoGraf, Laird Technologies	Thermal Interface Materials and Conductive Gaskets	7-9
Sierra Lobo, Aerospace Fabrication and Materials	Sun Shields	4 – 7
NASA Goddard Space Flight Center (GSFC)	Thermal Louvers	7-9



Aerospace Fabrication and Materials, Thermal Management Technologies	Deployable Radiators	5-6
Aavid Thermacore, Inc., Advanced Cooling Technology, Inc., Redwire Space	Heat Pipes	7-9
Thermal Management Technologies, Active Space Technologies, Advanced Cooling Technology, Inc.	Phase Change Materials/ Thermal Storage Units	7-9
Starsys, Redwire Space	Thermal switches	7-9
Thermal Management Technologies	Multifunctional Thermal Structures	4-5

7.2.1 Paints, Coatings, and Tapes

In a vacuum, heat is transferred only by radiation and conduction, with no convection. The internal environment of a fully enclosed small satellite is usually dominated by conductive heat transfer, while heat transfer to/from the outside environment is driven via thermal radiation.

The thermal radiation band of the electromagnetic spectrum is between 0.1 and 100 μm in wavelength, as shown in figure 7.2. Outside of the thermal radiation waveband, electromagnetic energy generally passes through objects or has very little heat energy under practical conditions. Thermal analyses are typically conducted using a two waveband absorptance model which subdivides the thermal energy spectrum into solar ($< 3 \mu\text{m}$) and IR ($> 3 \mu\text{m}$) wavelengths.

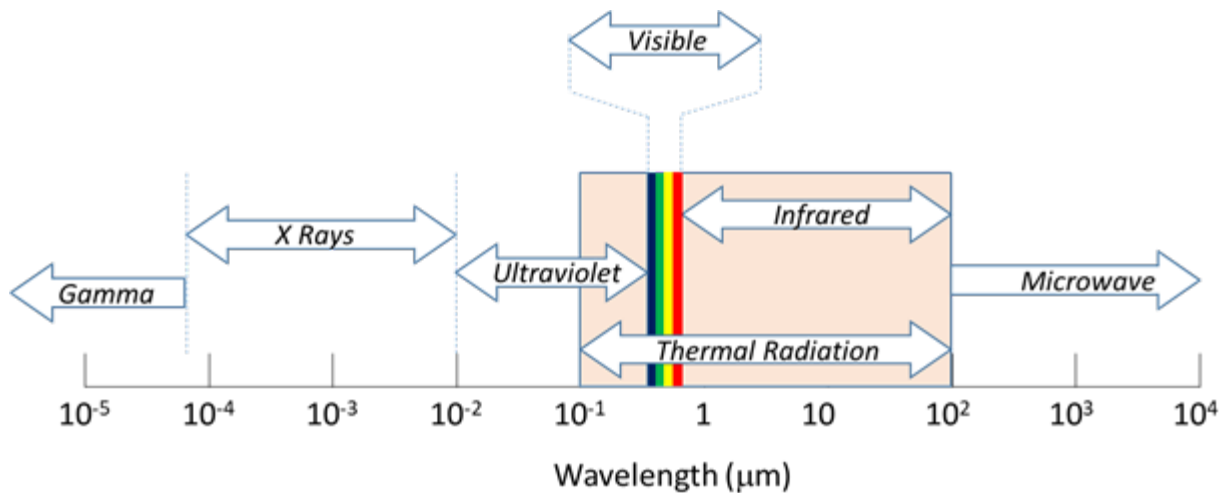


Figure 7.2: Electromagnetic spectrum showing the range of Thermal Radiation. Credit: NASA.

Thermal radiation heat transfer is controlled by using materials that have specific optical surface properties, namely: solar absorptivity and IR emissivity. Solar absorptivity governs how much incident heating from solar radiation a spacecraft absorbs, while IR emissivity determines how much heat a spacecraft emits to space, relative to a perfect blackbody emitter, and what fraction of thermal radiation from IR sources (e.g., the Earth, Moon, any particularly hot spacecraft components) are absorbed by that spacecraft surface.



The surface properties of a spacecraft can be modified by adding specialized paints, coatings, surface finishes, or adhesive tapes, depending on the needs of the spacecraft. For example, matte black paint has a high solar absorptivity and high IR emissivity for surfaces required to absorb a high percentage of solar heating and emit a high percentage of spacecraft heat. Alternatively, matte white paint has a low solar absorptivity and high IR emissivity (1) for surfaces required to absorb a low percentage of solar heating and emit a high percentage of spacecraft heat. Second-surface silver Fluorinated Ethylene Propylene (FEP) tapes offer excellent performance as radiator coatings, reflecting incident solar energy (low solar absorptivity) while simultaneously emitting spacecraft thermal energy efficiently (high IR emissivity). The selection between paints, coatings, and tapes depends on the application. Tape is typically easy to apply and remove, is comparatively inexpensive, and has a longer usable lifetime than paint (2). Tape can also be added later in the assembly process if changes to thermal control need to be made after the spacecraft has already begun assembly. Some tapes, however, must be handled carefully to maintain optical properties and can be difficult to bond properly to curved surfaces. Coatings and paints must often be applied earlier in the assembly process but can cover non-flat surfaces more easily. Some paints, like Parker-Lord's Aeroglaze 306/307, are expensive and require extensive and highly specialized processes to apply, however. Different options may also have different temperature limits. All these factors must be considered with regard to the needed application when selecting the final solution.

AZ Technology, MAP, Astral Technology Unlimited, Inc., Parker-Lord, Inc., Sheldahl, and AkzoNobel Aerospace Coatings manufacture thermal paint, coatings, and tapes for aerospace use that have been demonstrated on multiple small spacecraft missions. Most manufacturers have catalogs and/or guidebooks that provide detailed product information, including optical properties, and application guidance (for example, Sheldahl provides "The Red Book," (3)) to aid design selection.

One example, BioSentinel, a 6U spacecraft in development at NASA Ames Research Center (ARC) that is currently slated to be launched as a secondary payload on the Artemis I mission (2021), makes extensive use of Sheldahl metallized tape coatings and second-surface silvered FEP tapes to control its external thermal radiative properties and overall energy balance (4). Another example, Picard, a 150 kg SmallSat, used white paint on the Sun pointing face to reduce the amount of solar flux absorbed and lower temperatures. For most small spacecraft projects to date, adhesive tapes, such as silver FEP, or other standard surface finishes (e.g., polishing, anodize, alodine) have been the preferred choices.

7.2.2 Multi-layer Insulation

A MLI blanket is typically comprised of multiple inner layers of a thin material with low IR emissivity and a durable outer layer. The amount of radiative heat transfer allowed is limited by the many layers of reflectors. The low IR emissivity layers are either perforated or alternated with thin netting to prevent conduction through the layers, thus forcing any heat transport to be limited to radiative heat transfer. The perforations allow the MLI to vent trapped gas once arriving on-orbit. MLI is used as a thermal radiation barrier to both protect spacecraft from incoming solar and IR flux, and to prevent undesired radiative heat dissipation. It is commonly used to maintain temperature ranges for electronics and batteries in-orbit.

MLI is delicate and performance drops drastically if compressed (causing a thermally conductive "short circuit"), so it should be used with caution or avoided altogether on the exterior of small satellites that fit into a deployer (e.g., P-POD, NLAS). MLI blankets can also pose a potential snagging hazard in these tight-fitting, pusher-spring style deployers. Additionally, MLI blankets tend to drop efficiency as size decreases because heat transfer through the blanket increases



closer to the blanket edges, and the specific attachment method has a large impact on performance because attachment to the spacecraft creates a heat path.

Due to these challenges, MLI generally does not perform as well on small spacecraft (more specifically CubeSat form factors) as on larger spacecraft. Surface coatings are typically less delicate and more appropriate for the exterior of a small spacecraft that will be deployed from a dispenser. Internal MLI blankets that do not receive direct solar thermal radiation can often be replaced by a variety of low emissivity tapes or coatings that perform equally well in that context, using less volume and at a potentially lower cost.

Dunmore Aerospace provides an option for cubesat developers to make their own MLI blanket with Satkit. (5) Satkit provides Dunmore's STARcrest MLI materials cut into manageable sizes, including a roll of outer layer material, a larger roll of inner layer material, and polyimide tapes for assembly and edge binding. The materials included in the kit have been flown in spaceflight applications before, but Satkit is currently TRL 6. Dunmore also offers polyimide film tape and MLI tape designed to insulate wires and cables on SmallSats and is TRL 7.

7.2.3 Thermal Straps

A thermal strap is a flexible, thermally conductive link added between a heat source and sink to conductively transfer heat. They are often used between high heat dissipating chips or components and a chassis wall or other radiator surface. Their flexibility prevents the addition of structural loads. Thermal straps can be made metal, traditionally copper or aluminum, or high conductivity carbon materials, such as graphite. They can be formed of multiple foil sheets or wound cables (also referred to as ropes and braids), with end blocks at each end to hold the sheets/cables in place and to mount or otherwise attach to the needed surfaces. Straps with more than two end blocks and multiple material combinations can also be produced and have been used on large spacecraft.

There are multiple companies that manufacture thermal straps for spaceflight. For example, Thermal Management Technologies manufactures standard flexible thermal straps in aluminum and copper foil layers or copper braids as shown in figure 7.3.

Custom thermal straps are also commonly fabricated and tested (6). Space Dynamics Laboratory (SDL) has pioneered solderless flexible thermal straps that contain no solder, epoxy, or other filler materials to maximize thermal performance. Figure 7.4 shows a comparison of the as-tested conductance for the same strap geometry fabricated with three different foil materials of aluminum, copper, and pyrolytic graphite sheets (PGS). SDL has supplied Utah State University with a PGS strap for the Active Thermal Architecture (ATA) project, a follow on to the ACCS project referenced in the cryocooler section. Advances in thermal straps are being developed to further increase heat transfer capability. Aavid, Boyd Corporation's thermal division, has designed thermal straps using their patented k-core technology that has an annealed pyrolytic graphite (APG) core within an encapsulating structure. These have greater conduction efficiency compared to traditional aluminum straps (7), as the k-Core increases the overall thermal conductivity. This technology has been fully designed and tested and is TRL 5 for small spacecraft application.



Figure 7.3: Flexible Thermal Straps. Credit: Thermal Management Technologies.

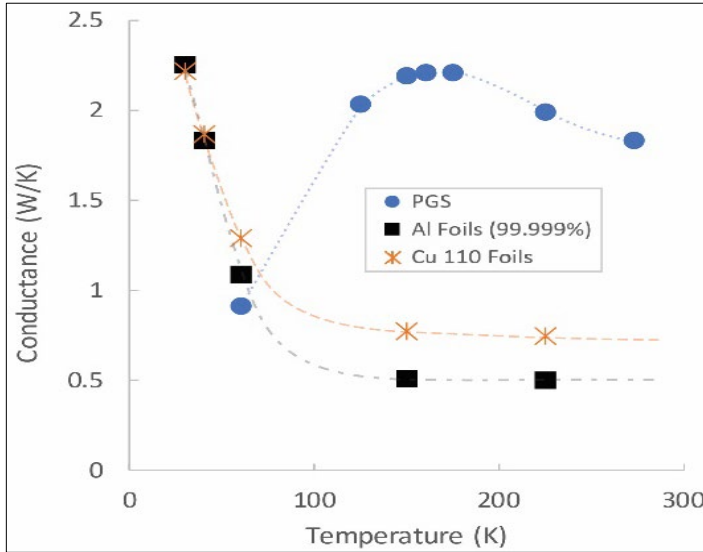


Figure 7.4: Thermal strap design with aluminum foils, copper foils, and PGS in aluminum end blocks (above), and their respective measured thermal conductance (left). The dashed lines connecting data points are based on material thermal conductivity curves. Credit: SDL.

Technology Applications, Inc. has specialized in testing and developing Graphite Fiber Thermal Straps (GFTS), with flight heritage on larger spacecraft missions (Orion and Spice). GFTS, shown in figure 7.5, are extremely lightweight and highly efficient and thermally conductive with unmatched vibration attenuation (8). While this technology has not been demonstrated on a small spacecraft, the fittings can only be made so small and most of the straps fall into a very typical size range with the end fitting thickness at a minimum of 0.10 – 0.30 in, with a thinner flexible section.



Figure 7.5: Graphite Fiber Thermal Straps (GFTS). Credit: Technology Applications, Inc.

Thermotive Technology developed the Two Arm Flexible Thermal Strap (TAFTS) that is currently flying on JPL’s Portable Remote Imaging Spectrometer (PRISM) instrument. Space infrared cameras require extremely flexible direct cooling of mechanically sensitive focal planes. The design of TAFTS uses three swaged terminals and a twisted section that allows for significant enhanced elastic movement and elastic displacements in three planes, while a more conventional strap of the same conductance offers less flexibility and asymmetrical elasticity (9). While infrared cameras have flown on small spacecraft missions, the TAFTS design has not been employed on a SmallSat.

The Pyrovo Pyrolytic Graphite Film (PGF) thermal straps developed by Thermotive have already flown in optical cooling applications for high altitude cameras and avionics on larger spacecraft. The specific thermal conductivity of this material has been shown to be 10x better than aluminum and 20x better than copper, as seen in figure 7.6 (10). These straps flew on JPL’s ASTERIA

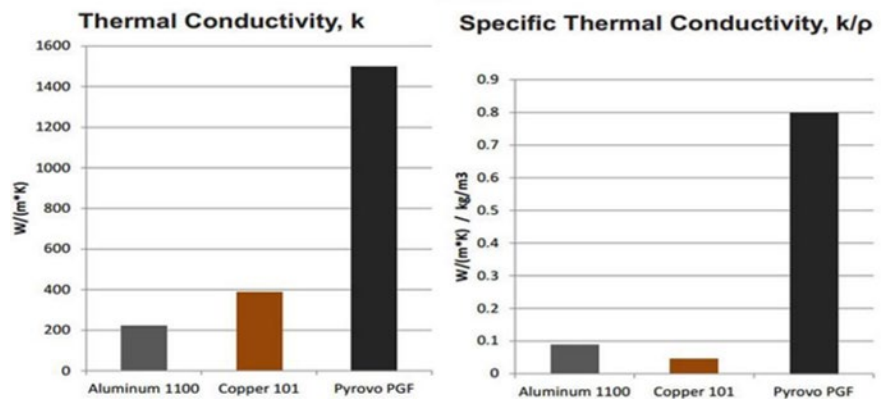


Figure 7.6: Pyrovo PGF Material Comparison. Credit: Thermotive Technology.

CubeSat in 2017 and is planned to be used on the Mars 2020 rover mission.

7.2.4 Thermal Interface Materials and Conductive Gaskets

Thermal interface materials are materials that are inserted between two components in order to increase the conductive heat transfer between them. They are often made as a sheet or pad of material to be sandwiched between surfaces, but there are many different types that vary in material, thickness, thermal conductivity, temperature limits, and vacuum-compatibility. Thermal interface materials can also be a grease or paste.

Thinner sheets of materials are commonly used between heat dissipating electronics boxes and mounting surfaces to thermally sink the hot components to a colder surface and reduce the temperature of the electronics. The performance of these types of materials depends on reaching a certain contact pressure between components to ensure the needed heat transfer. Laird Performance Materials has developed many different types of thermal interface materials for a variety of applications. For example, their Tflex series, shown in figure 7.7, is about 1 to 5 mm thick with a thermal conductivity of 6 W mK^{-1} (11), whereas their Tgon series of materials are about 0.13 to 0.5 mm thick with a thermal conductivity of 5 W mK^{-1} (12).

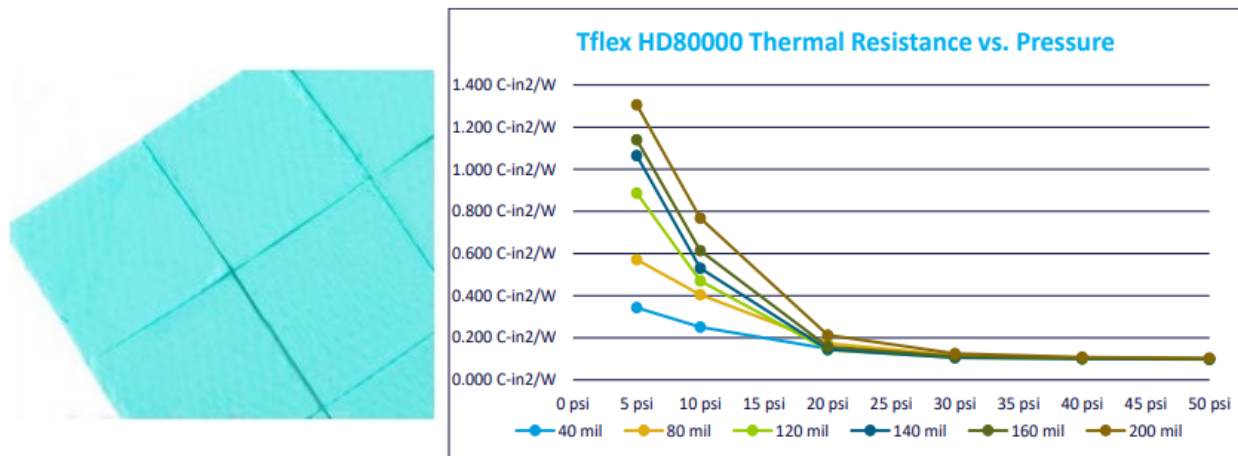


Figure 7.7: Laird Tflex HD80000 series sheets (left) and Thermal Resistance vs. Pressure (right). Credit: Laird Performance Materials.

Thicker pad-like materials, such as Henkel brand GAP PADS®, are often used between high heat dissipating chips on an electronics boards and the electronics enclosure. These are also made to fit a variety of applications, with varying material, thickness, conformability, tear-resistance, electrical isolation, thermal conductivity, and more (13). Several additional thermal interface materials developed by Henkel Corporation are shown in figure 7.8.

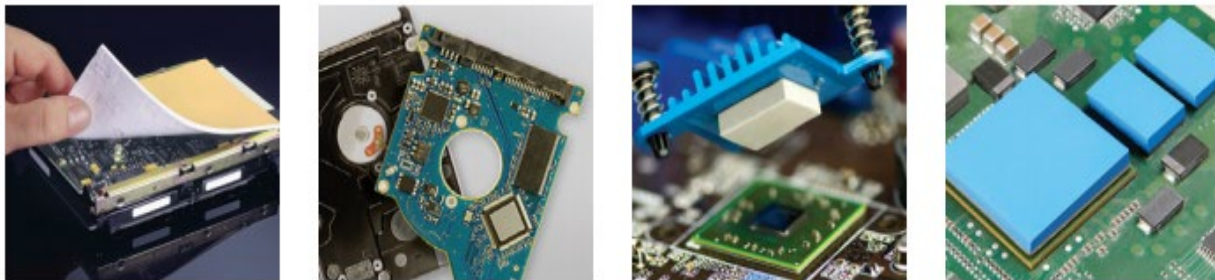


Figure 7.8: A variety of thermal interface materials. Credit: Henkel Corporation.

7.2.5 Sunshields

A sunshield, or sunshade, is an often-deployed device made up of a material with low solar absorptivity that reduces the amount of incident solar flux impinging a spacecraft, by blocking the view to the sun. Sunshields are commonly used for spacecraft thermal control, although only recently on small spacecraft. Sierra Lobo developed a deployable sunshield that flew on CryoCube-1, shown in figure 7.9, which was launched on Dragon CRS-19 in February 2020. In low-Earth orbit, this sunshield can support a multiple month-long duration lifetime and can provide temperatures below 100 K and below 30 K with additional cooling (14).

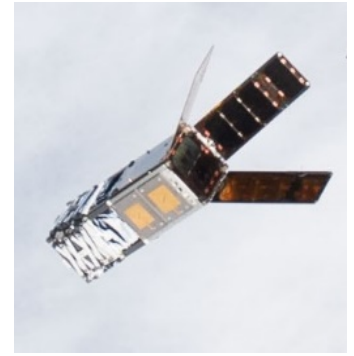
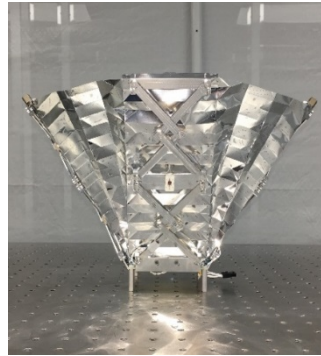


Figure 7.9: Deployed Sunshield on CryoCube-1 (left) and CryoCube-1 in orbit with shield stowed (right). Credit: Sierra Lobo (left) and NASA (right).

7.2.6 Thermal Louvers

Thermal louvers are thermally activated shutters that regulate how much heat the louvered surface can dissipate. As the louvers open, the average IR emissivity of the surface changes, changing how much heat the surface dissipates. Full-sized louvers on larger spacecraft have high efficacy for thermal control, however, integration on small spacecraft is challenging. Typical spacecraft louvers are associated with a larger mass and input power, which are both limited on small spacecraft.

Although commonly defined as active thermal control, here we consider louvers as a passive thermal control component because the Cubesat-adapted design considered does not require a power input from the spacecraft. NASA GSFC has developed a passive thermal louver that uses bimetallic springs to control the position of the flaps; when the temperature of the spacecraft rises, the springs expand, opening the louvers to modify the average IR emissivity of the exterior surface. Similarly, when the spacecraft cools and the flaps close, the exterior surface returns to the previous optical properties (15). The louvers were developed for a 6U CubeSat, Dellinger, which was released from the NanoRacks CubeSat Deployer on the International Space Station (ISS) into low-Earth orbit in late 2017 (16), and has a demonstrated thermal dissipation of 14 W. This louver design is illustrated in figure 7.10.



Figure 7.10: Passive Thermal Louver on 6U CubeSat Dellinger. Credit: NASA GSFC.

7.2.7 Deployable Radiators

A radiator is a dedicated surface for dissipating excess heat via radiative heat transfer and has a high IR emissivity and low solar absorptivity, an optical property combination typically referred to as “radiator properties.” A deployable radiator is stowed during transit or when the radiator is not needed and deployed when excess heat dissipation is required. Deployable radiators on small spacecraft can be challenging due to volumetric constraints. While paint has been widely used to create efficient radiator surfaces on larger spacecraft, the relatively limited available external surface area on SmallSats that already have body-mounted solar cells reduces the potential for creating dedicated radiative surfaces. For a system that requires a large amount of heat

dissipation, a passive deployable radiator would greatly enhance thermal performance by increasing the available radiative surface area. There has been steady development in this technology over the last five years and radiator designs for SmallSats have improved to TRL 5.

Thermal Management Technologies has developed thermally efficient deployable radiators for small spacecraft that integrate a radiator surface with a high-conductance hinge. The thermally conductive hinge causes minimal temperature gradients between the radiator and spacecraft; thus, the radiator can operate near spacecraft temperatures. Figure 7.11 shows the radiator design. The radiating surface uses graphite composite material for mass reduction and increased stiffness, where the typical radiator uniformity is less than $0.1^{\circ}\text{C W}^{-1}\text{ m}^{-1}$. This technology is currently in the development and testing phase (17).

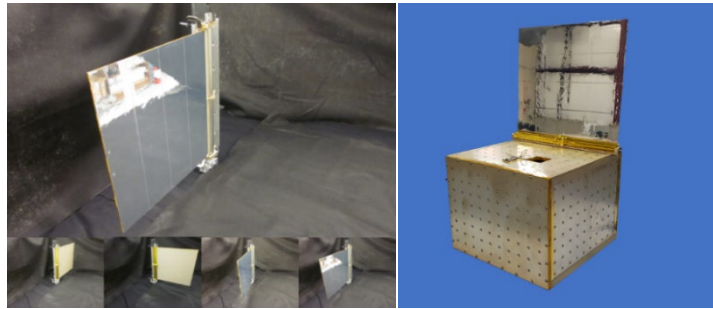


Figure 7.11: 100W deployable radiator (left), and radiator shown on ESPA structure (right). Credit: Thermal Management Technologies.

The design of a flexible deployable radiator for small spacecraft was developed and tested by Shoya Ono, Hosei Nagano, and colleagues from Kaneka Corporation and JAXA in 2015. This design can deploy or stow the radiation area to control heat dissipation depending on environmental temperatures. It has an overall volume of $0.5 \times 360 \times 560$ mm and 0.287 kg total mass. The radiator is passively stowed and deployed by an actuator made of a shape memory alloy and bias spring. To increase radiator size and thermal conductivity, multiple layers of Kaneka Graphite Sheets (KGS) are used for the fin material. The rear surface of the fin is insulated with MLI to reduce the amount of heat dissipation under cold conditions. Deployment and stowage tests were conducted in a thermostatic chamber, and the thermal performance test was conducted under vacuum conditions, where it was shown that the half-scaled radiator dissipated 54 W at 60°C (18).

Thermotive is researching the Folding Elastic Thermal Surface (FETS), a deployable passive radiator for hosted payload instruments and CubeSats. Originally conceived as a thermal shield and cover for a passive cooler (cryogenic radiator) on JPL's MATMOS mission, this proposed concept is being modified as a deployable radiator for small spacecraft (19).

Since deployable radiators may be needed because of a lack of radiator surfaces on the spacecraft body due to body-mounted solar cells, an alternate option is to use the chassis body as radiator area and have a deployable solar array. Also, deployed solar arrays would be able to radiate off a high emissivity/low solar absorptance backside for improved thermal management of the array.

7.2.8 Heat Pipes

A traditional heat pipe is a passive device comprised of a metal container (pipe) that holds a liquid under pressure and has a porous wick-like structure within the container. When heat is applied to one end of the tube, the liquid inside the tube near the hot end vaporizes into a gas that moves through the tube to the cooler end, where it condenses back into a liquid. The wick transports the condensed liquid back to the hot end via capillary action. There are also more complicated and non-passive types of heat pipes such as variable conductance, diode, and loop heat pipes, which are not further explained in this document.

Heat pipes are an efficient passive thermal transfer technology, where a closed-loop system transports excess heat via temperature gradients, typically from electrical devices to a colder surface, which is often either a radiator itself, or a heat sink that is thermally coupled to a radiator. Traditional constant conductance heat pipes are cylindrical in shape with a grooved inner wick, like those used on Bi-Spectral Infrared Detection (BIRD), a 92 kg satellite launched in 2001, to join satellite segments (20), see figure 7.12. Heat pipes can also be configured as flat plates with tubing sandwiched between two plates and charged with a working fluid inside. SDS-4, a 50 kg small spacecraft launched in 2012, incorporated the Flat-Plate Heat Pipe On-Orbit Experiment (FOX), developed at JAXA (21).

Redwire Space has developed a conformable micro heat pipe thermal management solution based on proprietary “FlexCool” technology for small satellites that is a cross between a heat pipe and a thermal strap (22). The conformable micro heat pipe flew on TechEdSat-10, a 6U CubeSat deployed from the ISS in 2020, to thermally manage the radio. An image of this technology in a 1U CubeSat model is shown in figure 7.13.

7.2.9 Phase Change Materials/ Thermal Storage Units

A phase change material used as a thermal storage unit is made up of a material (e.g., wax) within a metal housing. A heat source is attached to the housing so that, as the source conducts heat to the enclosure, the phase change material within absorbs the energy as it changes phase (usually from solid to liquid). Then, as the heat source energy output reduces, the phase change material releases the energy as it changes back to its initial phase (usually from liquid to solid). Owing to the low thermal conductivity of the phase change material, the metal housing must conduct heat into the phase change medium for efficient solidification or melting. Thermal storage units are typically used with components that will experience repeated temperature cycling. They can be challenging to apply to CubeSats and other small satellites because of the extra mass of the housing needed.

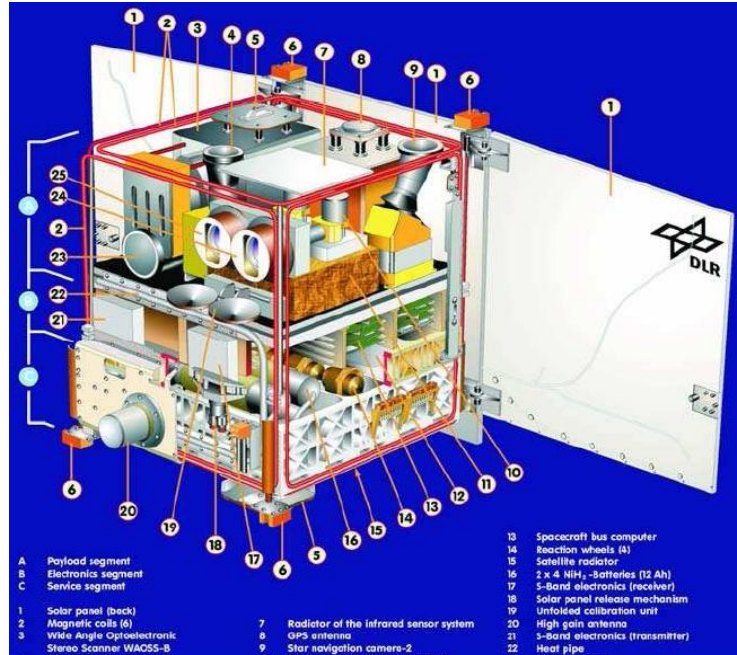


Figure 7.12: Diagram of BIRD, heat pipe denoted by #22. Credit: DLR-OS (DLR Institute of Optical Sensor Systems).

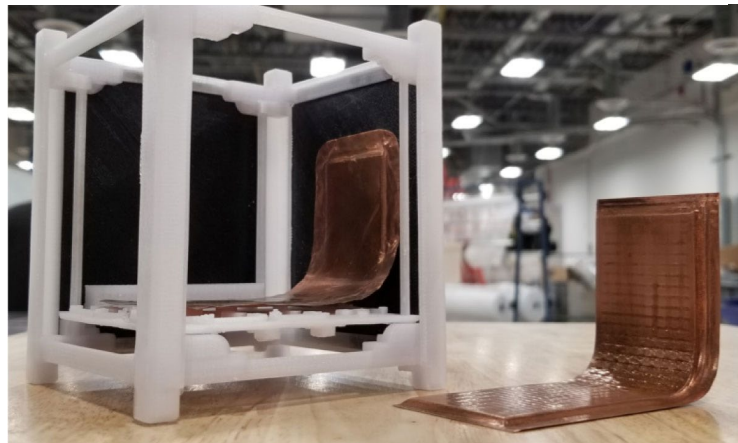


Figure 7.13: FlexCool conformable micro heat pipe before integrating with TechEdSat-10 DVB-S2 radio. Source: Redwire Space.

Thermal Management Technologies has developed a phase-changing thermal storage unit (TSU) that considers desired phase-change temperatures, interfaces, temperature stability, stored energy, and heat removal methodologies, as shown in figure 7.14. This device will allow the user to control temperature peaks, stable temperatures and/or energy storage (36).

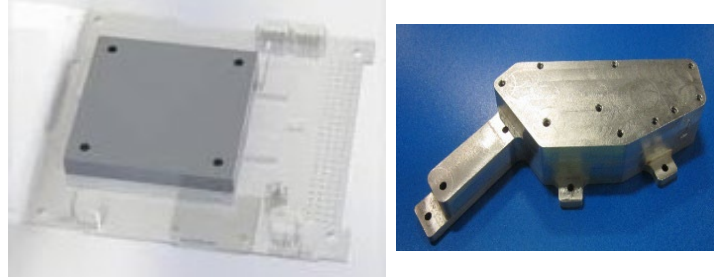


Figure 7.14: CubeSat Thermal Storage Unit. Credit: Thermal Management Technologies.

7.2.10 Thermal Switches

A thermal switch is a device that switches a heat conduction path between either a strong thermal coupling or weak thermal coupling (thermal insulation) as needed to control the temperature of heat producing components. A switch typically connects a heat producing component and a low temperature sink, such as a radiator. Heat switches differ from thermostats in that they passively modulate a thermal coupling while thermostats modulate heater circuits (23). Part of the challenge in integrating a thermal switch in SmallSats is that they take up additional space between a component and heat sink. Typical, heat switches may provide a conduction ratio of 10:1 with a technology goal of 100:1 (24). This technology is rated at TRL 7 – 9.

7.2.11 Multifunctional Thermal Structures

A newer development in passive thermal control for small spacecraft are multi-functional thermal structures. These integrate thermal control capabilities directly into the structure. This is particularly advantageous for small spacecraft due to strict mass and volume constraints. Currently, Thermal Management Technologies has adapted its multifunction heat spreading structure technology, scaled it to smaller satellite configurations, and called it Standard Passive Orbital Thermal-control (SPOT) Structures. SPOT Structures come in four standard configurations: 6U, 12U, Launch U, and ESPA (25). Each incorporates heat-spreading technology that improves the ability to radiate waste heat. They incorporate features such as low mass, high stiffness/strength, and integrated heat pipes. This new technology is at TRL 4.

7.3 State-of-the-Art – Active Systems

Active thermal control methods rely on input power for operation and have been shown to be more effective in maintaining tighter temperature control for components with stricter temperature requirements or higher heat loads (26). Typical active thermal devices used on large-scale spacecraft include electrical resistance heaters, cryocoolers, thermoelectric coolers, and fluid loops. Electrical heaters are usually easily integrated into SmallSat architecture as they do not typically use much mass or volume. Heaters are frequently used in all space applications, including small and large satellites, so they are often included as passive thermal control technology. Other active systems are challenging to integrate into CubeSats and other small satellites because of the power, mass, and volume needs associated with each given technology. Until spacecraft designers can miniaturize existing actively controlled thermal techniques and reduce power requirements or increase available spacecraft power, the use of active thermal systems in small spacecraft will be limited.

The current state-of-the-art of active thermal technologies in SmallSats is shown in table 7-3.



Manufacturer	Products	TRL in LEO Environment
Minco Products, Inc., Birk Manufacturing, All Flex Flexible Circuits, LLC., Fralock, Tayco Engineering, Inc., Omega	Electrical Heaters	7-9
Ricor-USA, Inc., Creare, Sunpower Inc., Northrop Grumman, NASA Jet Propulsion Lab, and Lockheed Martin Space Systems Company	Cryocoolers	5-6
Marlow, TE Technology Inc., Laird	Thermoelectric Coolers (TEC)	7-9
Lockheed Martin	Fluid Loops	4-5
NASA Small Spacecraft Technology program	Active Thermal Architecture (ATA)	4-6

7.3.1 Heaters

Electrical resistance heaters used on small spacecraft are most often Kapton heaters, which consist of a polyimide film with etched foil circuits that produce heat when a current is applied. Kapton heaters also often have a pressure sensitive adhesive on one side for easy application. Heaters are typically used in cold environments to maintain battery temperature, which is usually the component with the narrowest temperature limits, and are controlled by a thermostat or temperature sensor. The low mass of SmallSats requires little additional heater power to maintain temperature limits, and so heaters do not typically need to be very high power to effectively manage temperatures.

The 1U CubeSats Compass-1, MASAT-1, and OUTFI-1 each required an electrical heater attached to the battery in addition to passive control for the entire spacecraft system to maintain thermal regulation in eclipses (27). Additionally, as biological payloads become more common on small spacecraft, their temperature limits must be considered and maintained as well. NASA ARC biological nanosats (GeneSat, PharmaSat, O/OREOS, SporeSat, EcAMSat, and BioSentinel) all use actively-controlled heaters for precise temperature maintenance for their biological payloads, with closed-loop temperature feedback to maintain temperatures.

7.3.2 Cryocoolers

Cryocoolers are refrigeration devices designed to cool around 100K and below. A summary of cryocooler systems is given in figure 7.15 and a detailed review of the basic types of cryocoolers and their applications is given by Radebaugh (28). The first two systems (a) and (b) are recuperative cycles, and (c), (d), and (e) are regenerative cycles. Cryocoolers are used on instruments or subsystems requiring cryogenic cooling, such as high precision IR sensors. Instruments such as imaging spectrometers, interferometers and midwave infrared (MWIR) sensors require cryocoolers to function at extremely low temperatures. The low temperature improves the dynamic range and extends the wavelength coverage. The use of cryocoolers is also associated with longer instrument lifetimes, low vibration, high thermodynamic efficiency, low mass, and supply cooling temperatures less than 50K (29).

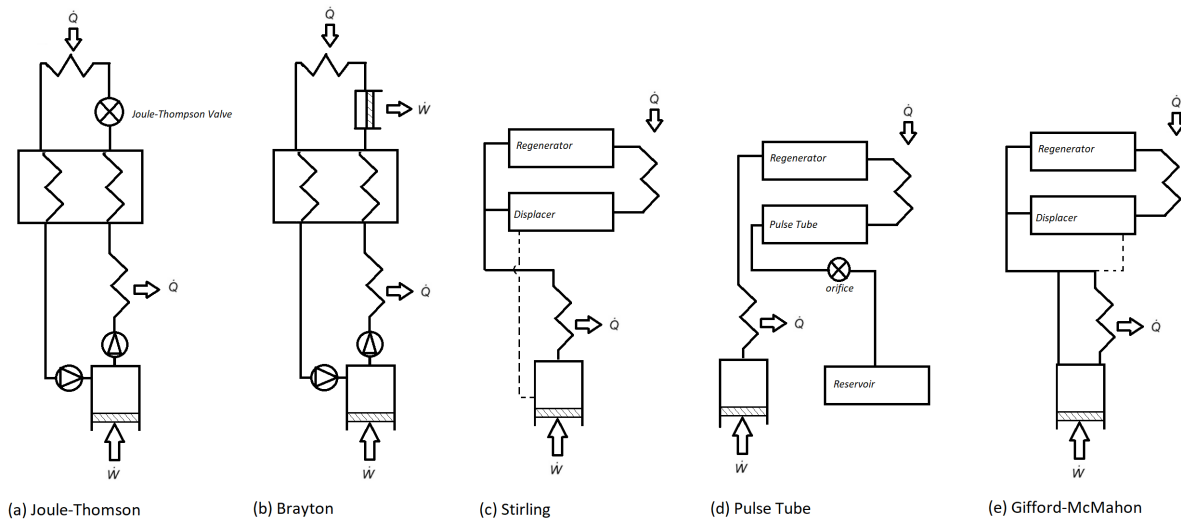


Figure 7.15: A comparison of cryocooler types. Credit: NASA.

Creare has developed an Ultra-Low Power (ULP) single-stage, turbo-Brayton cryocooler that operates between a cryogenic heat rejection temperature and the primary load temperature. The cryocooler includes a cryogenic compressor, a recuperative heat exchanger, and a turboalternator. The continuous flow nature of the cycle allows the cycle gas to be transported from the compressor outlet to a heat rejection radiator at the warm end of the cryocooler and from the turboalternator outlet to the object to be cooled at the cold end of the cryocooler (30). This cryocooler is designed to operate at cold end temperatures of 30 to 70K, with loads of up to 3 W, and heat rejection temperatures of up to 210K by changing only the charge pressure and turbo machine operating speeds. This technology has completed testing and fabrication and is TRL 6. The development of this technology has not specifically targeted small satellite applications, but with its comparatively low power requirements could be adapted to SmallSats in the future.

A reverse turbo-Brayton cryocooler that produces negligible vibration, is also being developed by Creare. This technology uses a continuous flow of gas to transport heat from the active elements of the cryocooler to the objects to be cooled and to heat rejection surfaces.

Ricor-USA, Inc. developed the K562S, a rotary Sterling mini micro-cooler. It has a cooling capacity of 200 mW at 95 K and 300 mW at 110K. It has been used in several small gimbals designed for military applications. Ricor also developed K508N, a Sterling 1/2 W micro cooler that has a cooling capacity of 500 mW at 77 K and 700 mW at 77K that is suitable for use on small spacecraft. These coolers, shown in figure 7.16, are TRL 6 for small spacecraft applications.

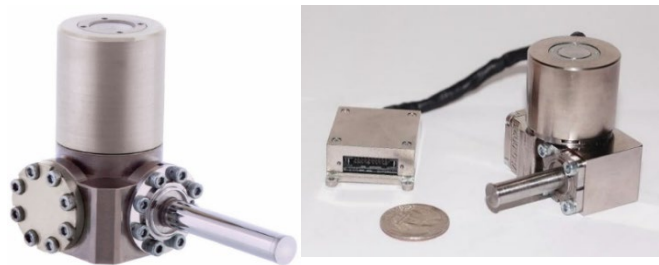


Figure 7.16: (left) K508N 1/2 W Micro Cooler, and (right) K562S Mini-cooler. Credit: Ricor-USA.

Sunpower, Inc. developed the CryoTel DS1.5 Sterling Cryocooler, shown in figure 7.17, featuring a dual-opposed-piston pressure wave generator and a separate cold head to minimize exported vibration and acoustic noise, and has a nominal heat lift of 1.4 W at 77K using 30 W power with a 1.2 kg mass (31). Sunpower also offers MT-F, a mini-cooler that has a nominal heat lift of 5 W at 77K, using 80 W power with a total mass of 2.1 kg. So far, these units have not been used in small spacecraft applications but are candidates given their size and performance.



Figure 7.17: (left) CryoTel DS1.5 1.4 W Cryocooler and (right) CryoTel MT-F 5 W Cryocooler. Credit: Sunpower, Inc.

Northrop Grumman designed a Micro Pulse Tube cooler that is a split-configuration cooler that incorporates a coaxial coldhead connected via a transfer line to a vibrationally balanced linear compressor. This micro compressor has been scaled from a flight proven, high efficiency cooler (HEC) compressor, although it has not operated on a SmallSat. It has a TRL of 6. The cooler has an operational range of 35 to 40K and a heat rejection temperature of 300K, using 80 W of input power, has 750 mW refrigeration at 40K, and a total mass of 7.4 kg (32).

Lockheed Martin Space Systems Company has engineered a pulse tube micro-cryocooler, a simplified Sterling cryocooler consisting of a compressor driving a coaxial pulse tube coldhead, shown in figure 7.18. The unit has a mass of 0.345 kg for the entire thermal mechanical unit, and is compact enough to be packaged in a ½U CubeSat (33). After qualification testing, the microcooler is at TRL 6 and is compatible with small spacecraft missions.



Figure 7.18: TRL6 Microcryocooler. Cryocooler Credit: Lockheed Martin.

Thales Cryogenics has also developed a Linear Pulse Tube (LPT) cryocooler that has gone through extensive testing by JPL. The Thales LPT9510 cryocooler has an operating temperature range of -40 to 71°C, an input power of <85 W, and a total unit mass of 2.1 kg. The unit has no flight heritage but has undergone extensive testing and is TRL 6 (34).

7.3.3 Thermoelectric Coolers (TEC)

A TEC is a solid-state heat pump that requires a heat exchanger to dissipate heat using the Peltier effect. During operation, current flows through the TEC to create heat transfer and a temperature differential across the ceramic substrates, causing one side of the TEC to be cold, while the other side is hot.

7.3.4 Fluid Loops

A pumped fluid loop (PFL) consists of a circulating pump that moves a liquid through tubing connected to a heat exchanger and heat sink. A heat source is mounted to the heat exchanger and the pumped fluid carries the heat from the source to a heat sink, typically a radiator, and then the cooled fluid is returned to the heat source to continue providing cooling. A PFL is capable of cooling multiple locations via forced fluid convective cooling. Mechanically pumped fluid loops (MPFL) are not typically used on SmallSats because they are associated with high power consumption and mass.

Lockheed Martin Corporation is developing a low mass circulator pump for a closed cycle Joule Thomson cryocooler, as shown in figure 7.19. With an overall mass of 0.2 kg, it can circulate gas as part of a single-phase or two-phase thermal management system using 1.2 W of electrical power and can manage around 40 W of spacecraft power as a single-phase loop, or several hundred Watts of spacecraft power as part of a 2-phase loop. The compressor went through applicable testing with a compression efficiency of 20 – 30% in a 2016 study (35). This design is TRL 4.

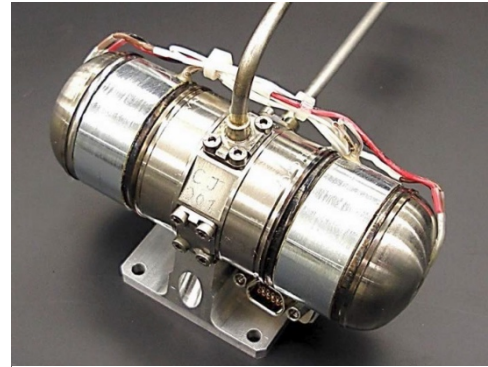


Figure 7.19: JT Compressor. Credit: Lockheed Martin.

7.3.5 Active Thermal Architecture

The ATA project is an advanced design effort to develop active thermal control technologies for small satellites in support of future advanced missions in deep space, helio-physics, earth science, and communications. The ATA project is led by the Center for Space Engineering at Utah State University (CSE, USU) and funded by the NASA Small Satellite Technology (SST) program in partnership with JPL.

The ATA is a 1U two-stage active thermal control system targeted at 6U CubeSat form factors and larger. The first stage consists of a mechanically pumped fluid loop (MPFL). A micro-pump circulates a working fluid between an internal integrated heat exchanger and a deployed tracking radiator. The second stage is a miniature tactical cryocooler, which directly provides cryogenic cooling to payload instrumentation. The conceptual operation of the ATA system is shown in figure 7.20.

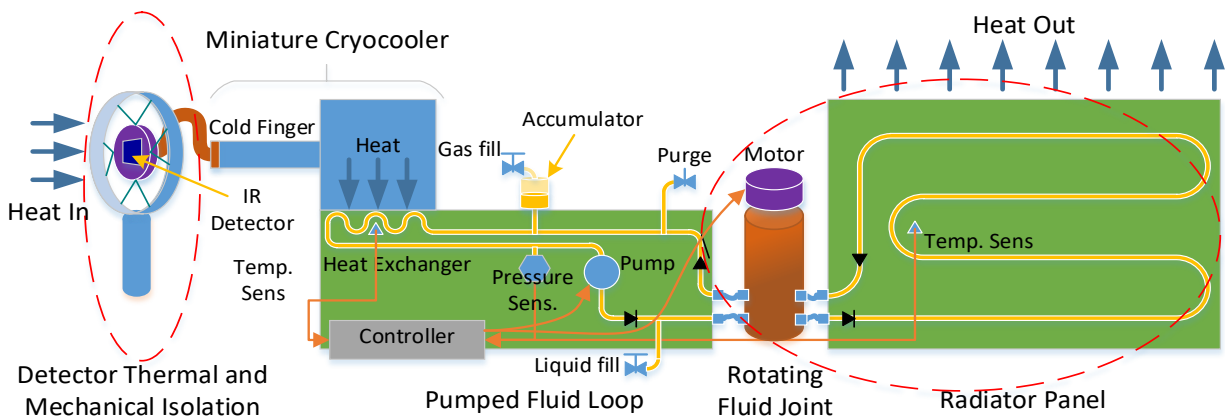


Figure 7.20: Conceptual operation of the ATA thermal control system. Credit: CSE/USU/NASA/JPL.

Ultrasonic additive manufacturing (UAM) techniques were used to simplify and miniaturize the ATA system by embedding the MPFL fluid channels directly into the integrated HX, CubeSat chassis, and the external radiator. The ATA system also features a dual rotary fluid union design, and an integrated geared micro-motor which allows for the two-stage deployment and solar tracking of the ATA radiator. The ATA also features passive vibration isolation and jitter cancellation technologies such as a floating wire-rope isolator design, particle damping, flexible PGS thermal links and a custom Kevlar isolated cryogenic electro-optical detector mount. Figure 7.21 shows some of the technologies developed for ATA as well as the ground-based prototype CubeSat.

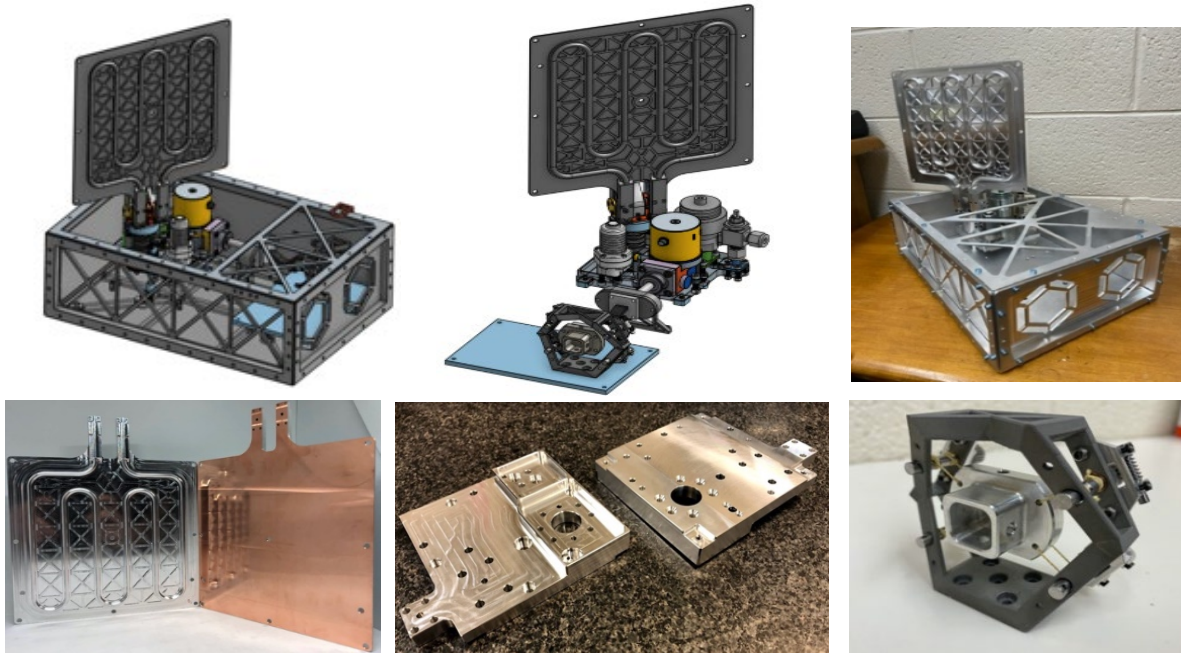


Figure 7.21: From top left: ATA CubeSat prototype, 1U ATA subsystem, ATA prototype, UAM radiator with copper backing, UAM heat exchanger, Kevlar isolated Cryogenic Electro-optical prototype mount. Credit: CSE/USU/NASA/JPL.

7.4 Summary

As thermal management on small spacecraft is limited by mass, surface area, volume and power constraints, traditional passive technologies, such as paints, coatings, tapes, MLI, and thermal straps, dominate thermal design. Active technologies, such as thin flexible resistance heaters have also seen significant use in small spacecraft, including some with advanced closed-loop control. Many technologies that have to date only been integrated on larger spacecraft are being designed, evaluated, and tested for small spacecraft to meet the growing needs of SmallSat developers as small satellites become more and more advanced. Passive louvers that have successfully flown on 6U Dillengr, and deployable solar panels that have been used by many other SmallSats are paving the way for thermal deployable components, while advanced deployable radiators and thermal storage units are still undergoing testing for small spacecraft.



Technology in active thermal control systems has started expanding to accommodate volume and power restrictions of a smaller spacecraft; cryocoolers are being designed to fit within 0.5U volume that will allow small spacecraft to use optical sensors and imaging spectrometers.

For feedback solicitation, please email: arc-sst-soa@mail.nasa.gov. Please include a business email.

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